

#### • General Description

The AGM025N10H combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

#### Application

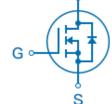
- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## **Product Summary**

BVDSS	RDSON	ID
100V	2.7mΩ	180A

### **TO-263 Pin Configuration**





Top View

**Bottom View** 

# **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM025N10H	AGM025N10H	TO-263	330mm	25mm	800

#### Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	180	А
_	Drain Current-Continuous(Tc=100℃)	126.6	Α
IDM (pluse)	Drain Current-Pulsed (Note 2)	720	А
PD	Maximum Power Dissipation(Tc=25℃)	250	W
	Maximum Power Dissipation(Tc=100℃)	100	w
EAS	Avalanche energy (Note 3)	1081	mJ
TJ,TSTG	TJ,TSTG Operating Junction and Storage Temperature Range		$^{\circ}$

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		62.5	°C/W
RøJC	Thermal Resistance Junction-Case <sup>1</sup>		0.50	°C/W



Table 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)

Table 3. Electrical Characteristics (TJ=25℃unless otherwise noted)					
Parameter	Conditions	Min	Тур	Max	Unit
ates					
Drain-Source Breakdown Voltage	VGS=0V ID=250µA	100			V
Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1	μA
Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
Gate Threshold Voltage	VDS=VGS,ID=250µA	2	3	4	V
Forward Transconductance	VDS=5V,ID=20A		50		S
Drain-Source On-State Resistance	VGS=10V, ID=50A		2.7	3.4	mΩ
Characteristics					
Input Capacitance	\/D\$=50\/\/C\$=0\/		9200		pF
Output Capacitance	F=1MHZ		1130		pF
Reverse Transfer Capacitance			110		pF
Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
g Times					
Turn-on Delay Time			32		nS
Turn-on Rise Time	VGS=10V.VDS=50V.		40		nS
Turn-Off Delay Time	RGEN=1.6Ω		80		nS
Turn-Off Fall Time			35		nS
Total Gate Charge			131		nC
Gate-Source Charge	VGS=10V, VDS=50V, ID=50A		50		nC
Gate-Drain Charge	1.5 00,1		24.5		nC
Source-Drain Diode Characteristics					
Source-Drain Current(Body Diode)				180	Α
Forward on Voltage	VGS=0V,IS=50A			1.2	V
Reverse Recovery Time	IF=50A , dI/dt=500A/μs ,		80		ns
Reverse Recovery Charge	TJ=25℃		195		nc
	Parameter ates  Drain-Source Breakdown Voltage Zero Gate Voltage Drain Current Gate-Body Leakage Current Gate Threshold Voltage Forward Transconductance Drain-Source On-State Resistance  Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate resistance Turn-on Delay Time Turn-on Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge rain Diode Characteristics Source-Drain Current(Body Diode) Forward on Voltage Reverse Recovery Time	Parameter         Conditions           ates         Urain-Source Breakdown Voltage         VGS=0V ID=250μA           Zero Gate Voltage Drain Current         VDS=100V,VGS=0V           Gate-Body Leakage Current         VGS=±20V,VDS=0V           Gate Threshold Voltage         VDS=VGS,ID=250μA           Forward Transconductance         VDS=5V,ID=20A           Drain-Source On-State Resistance         VGS=10V, ID=50A           Characteristics           Input Capacitance         VDS=50V,VGS=0V, F=1MHZ           Reverse Transfer Capacitance         VGS=0V, VDS=0V, F=1.0MHz           3 Times         Turn-on Delay Time         VGS=0V, VDS=50V, RGEN=1.0MHz           3 Times         Turn-Off Delay Time         VGS=10V, VDS=50V, RGEN=1.6Ω           Turn-Off Fall Time         VGS=10V, VDS=50V, ID=50A           Total Gate Charge         VGS=10V, VDS=50V, ID=50A           Gate-Drain Charge         VGS=10V, VDS=50V, ID=50A           Forward on Voltage         VGS=0V,IS=50A           Reverse Recovery Time         IF=50A, dl/dt=500A/μs, TL=26.0	Parameter   Conditions   Min ates	Parameter   Conditions   Min   Typ     ates	Parameter   Conditions   Min   Typ   Max

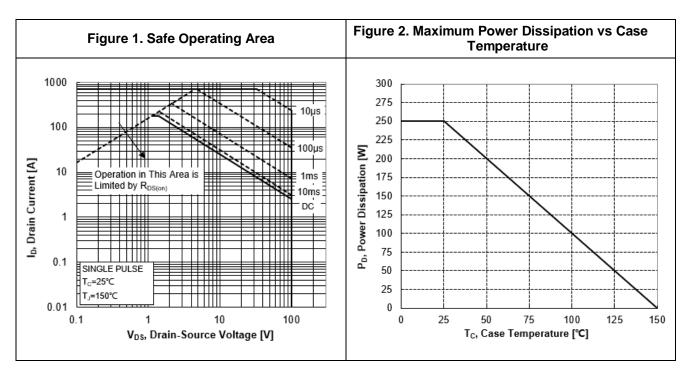
Notes 1. The maximum current rating is package limited.

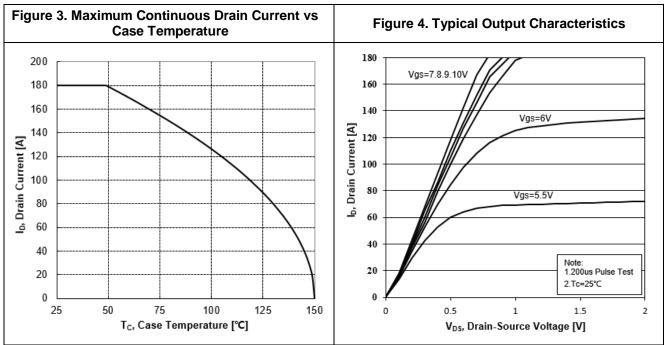
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25℃

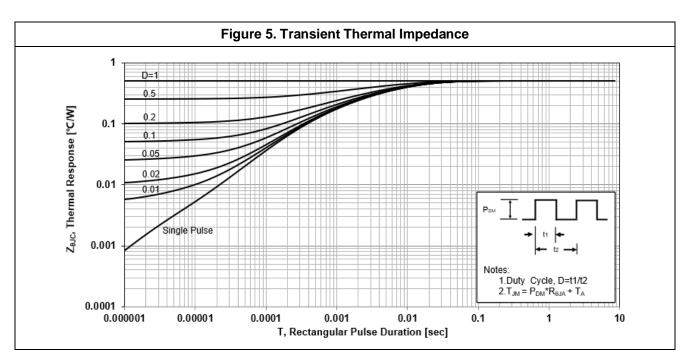


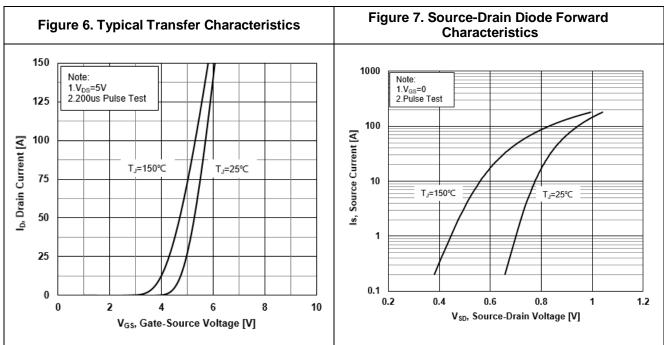
# **Characteristics Curves**



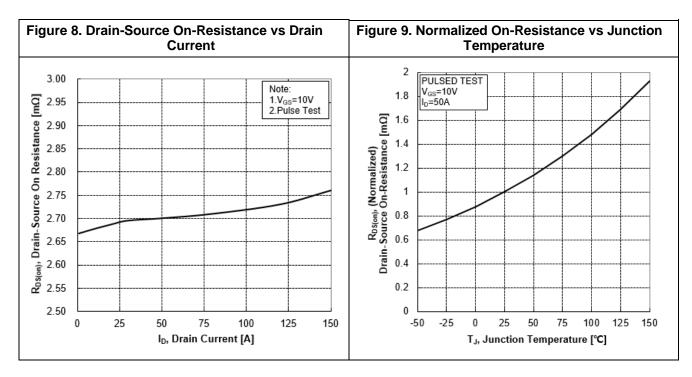


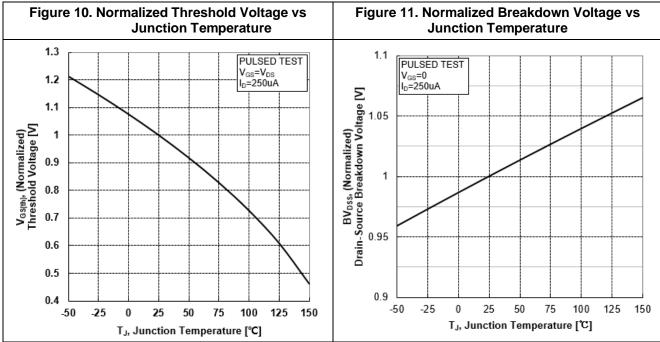




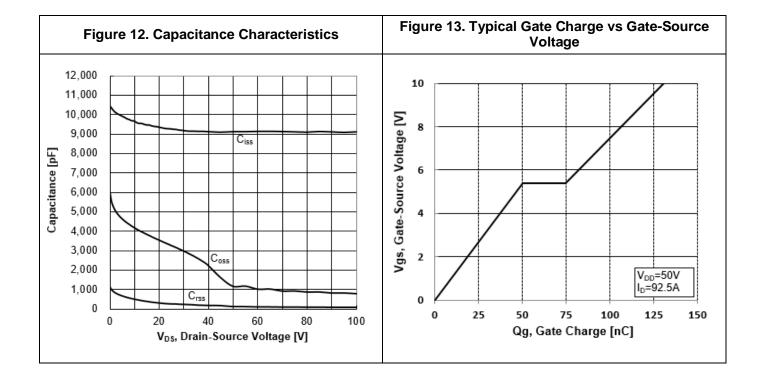






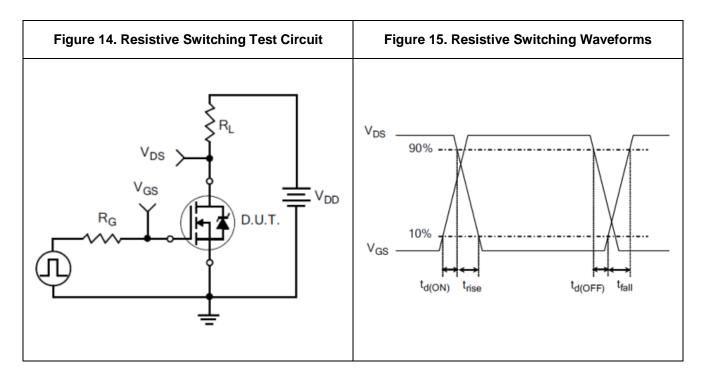


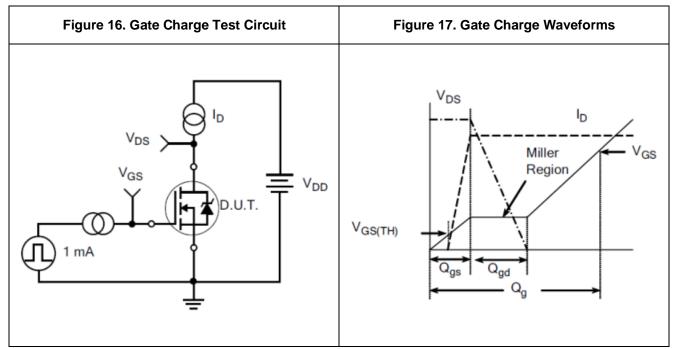




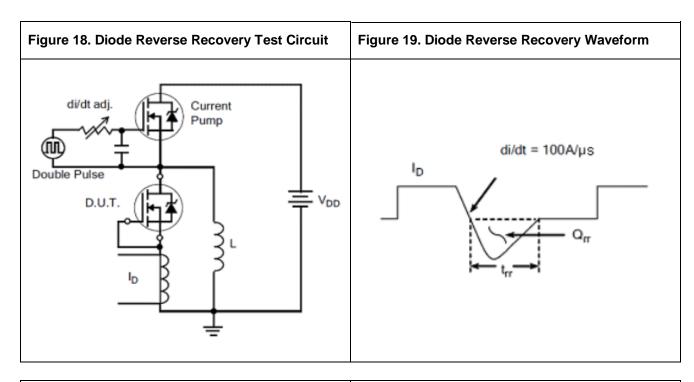


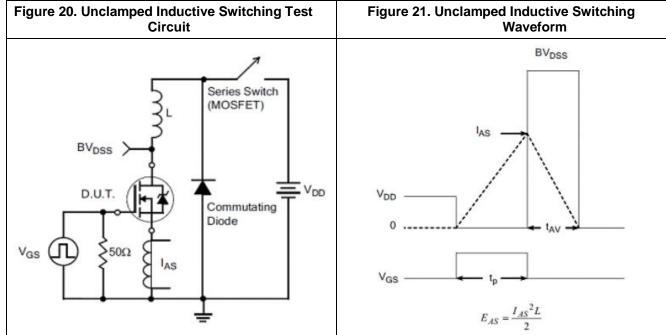
# **Test Circuit and Waveform**





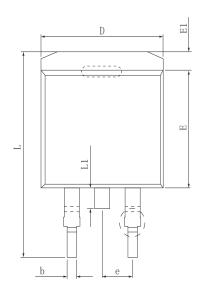


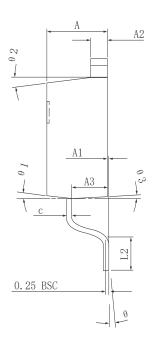


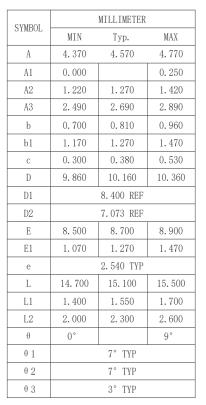


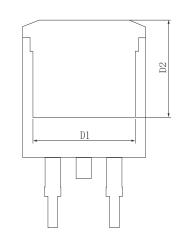


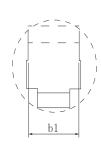
# •Dimensions (TO-263)

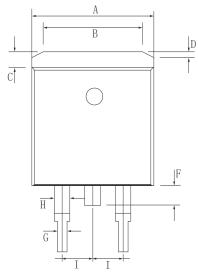


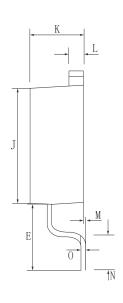








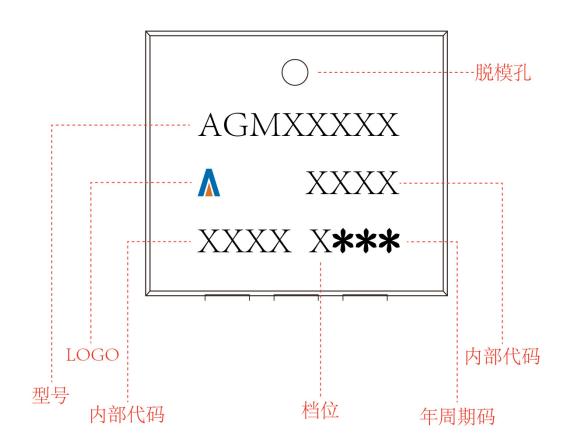




Dim.	Min.	Max.			
A	9.8	10.2			
В	6. 1	6. 7			
С	1. 1	1.4			
D	0.5	1.0			
Е	4.6	5.0			
F	1.4	1.6			
G	0.7	0.9			
Н	1. 17	1. 37			
Ι	Тур2. 54				
J	9	9.2			
K	4. 3	4.7			
L	1. 25	1. 35			
M	0.02	0. 23			
N	2. 2	2.8			
0	0.45	0.55			
All Dimensions in millimeter					



TO-263 Marking Instructions:





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